

# ML485

## 1.5-3.2 GHz High IP3 Mixer with Integrated LO Amp

### Applications

- PCS / 3G Base station / Repeaters
- WCDMA / LTE
- WiMax / WiBro
- ISM / Fixed Wireless
- HPA Feedback Paths

### Product Features

- High Dynamic Range Mixer with Integrated LO Driver
- +35 dBm Input IP3
- 8 dB Conversion Loss
- RF: 1500 – 3200 MHz
- LO: 1400 – 3500 MHz
- IF: 50 – 300 MHz
- +5V Supply @ 40 mA
- 0 dBm Drive Level
- RoHS-compliant MSOP8 (14 mm<sup>2</sup>)

### General Description

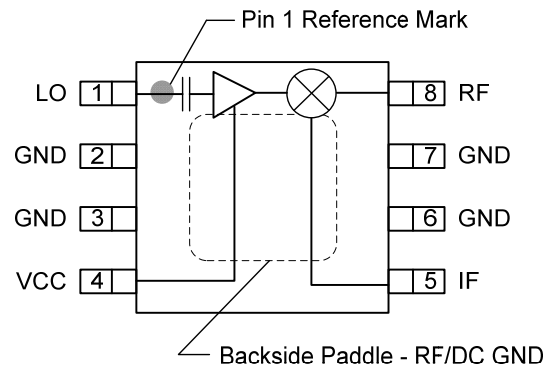
The ML485 high linearity converter combines a passive GaAsFET mixer with an integrated LO driver in an ultra-small lead-free/green/RoHS-compliant MSOP-8 package. The double-balanced integrated IC is able to operate across a wide 1.5-3.2 GHz frequency range to achieve +35 dBm Input IP3 while drawing a very low 40mA current. The ML485 can be used as an up-converter or down-converter in a low-side or high-side LO configuration.

A LO buffer amplifier is integrated on the chip to allow for operation directly from a synthesizer requiring only 0 dBm of LO drive level. The dual-stage LO driver provides a stable input power level into the mixer to allow for consistent performance over a wide range of LO power levels. The converter requires no external baluns and supports a wide range of IF frequencies.

Typical applications include frequency up/down conversion, modulation and demodulation for receivers and transmitters used in 2.5G and 3G mobile infrastructure. Due to the wide frequency range of operation, the converter can also be used for WiMAX, WiBro, ISM, LTE and fixed wireless applications



### Functional Block Diagram



### Pin Configuration

| Pin #           | Symbol |
|-----------------|--------|
| 1               | LO     |
| 2, 3, 6, 7      | GND    |
| 4               | Vcc    |
| 5               | IF     |
| 8               | RF     |
| Backside Paddle | GND    |

### Ordering Information

| Part No.  | Description                            |
|-----------|--|
| ML485     | 1.5-3.2 GHz Mixer w/ Integrated LO Amp |
| ML485-PCB | Fully Assembled Evaluation Board       |

Standard T/R size = 1000 pieces on a 7" reel.

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### Specifications

#### Absolute Maximum Ratings

| Parameter                      | Rating      |
|--------------------------------|-------------|
| Storage Temperature            | -65 to +150 |
| DC Voltage                     | +7 V        |
| Input IF / RF Power, CW, +25°C | +27 dBm     |
| LO Power                       | +10 dBm     |

Operation of this device outside the parameter ranges given above may cause permanent damage.

#### Recommended Operating Conditions

| Parameter  | Min   | Typ | Max   | Unit |
|--|-------|-----|-------|------|
| V <sub>cc</sub>                                  | +4.75 | +5  | +5.25 | V    |
| T <sub>J</sub> (for >10 <sup>6</sup> hours MTTF) |       |     | 150   | °C   |
| Operational Temperature                          | -40   |     | +85   | °C   |

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

#### Electrical Specifications

Test conditions unless otherwise noted: V<sub>cc</sub>+5V, Temp=+25°C,. (see note 1)

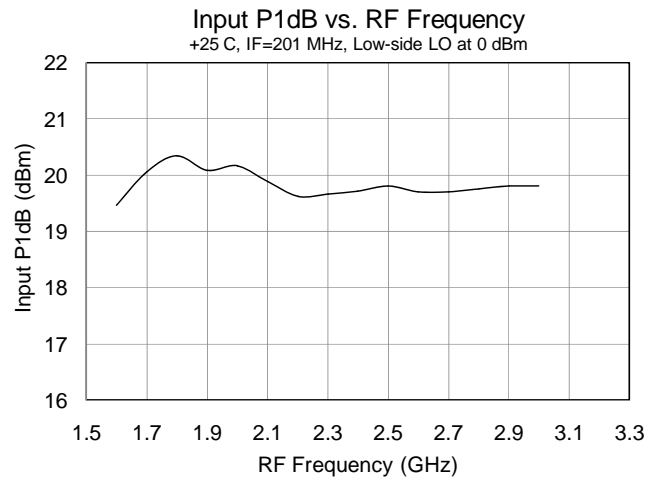
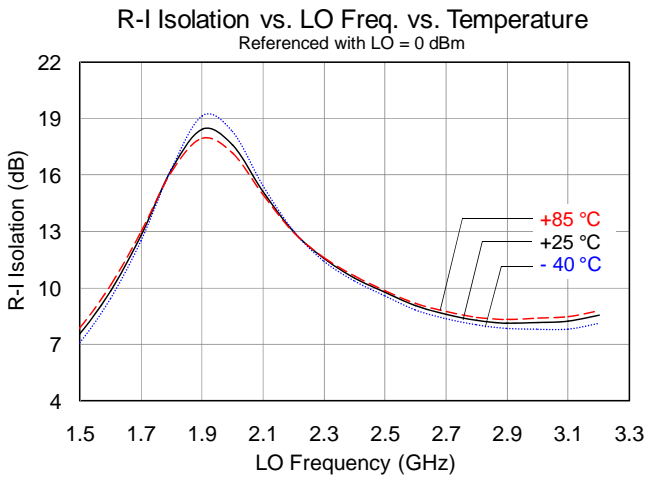
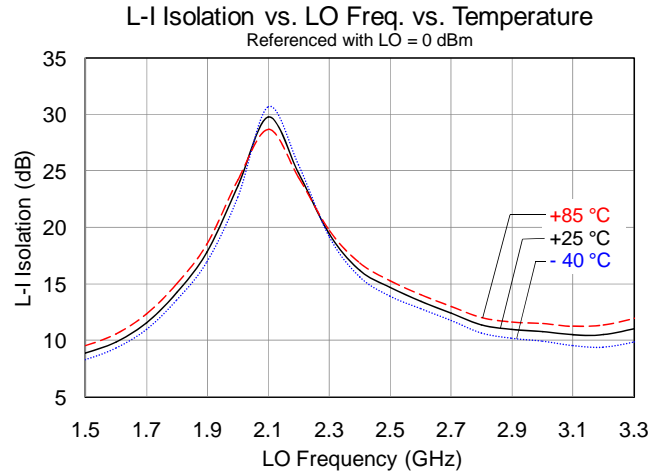
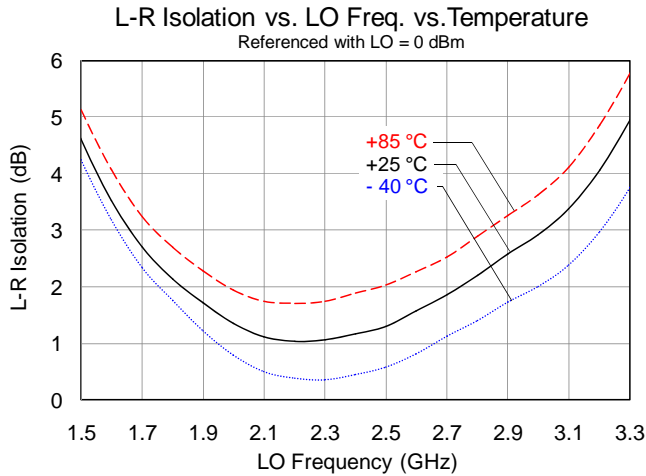
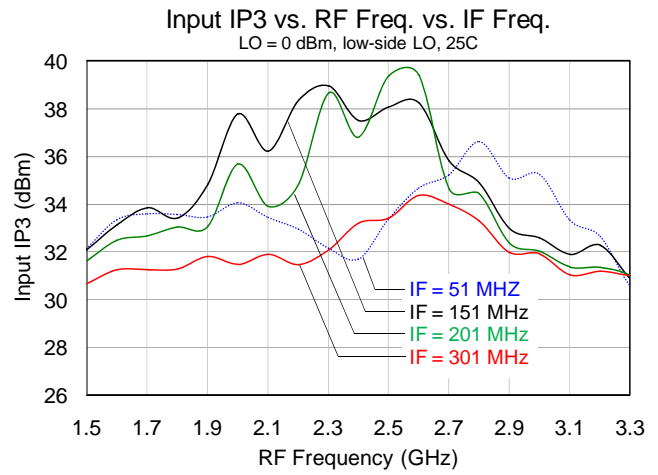
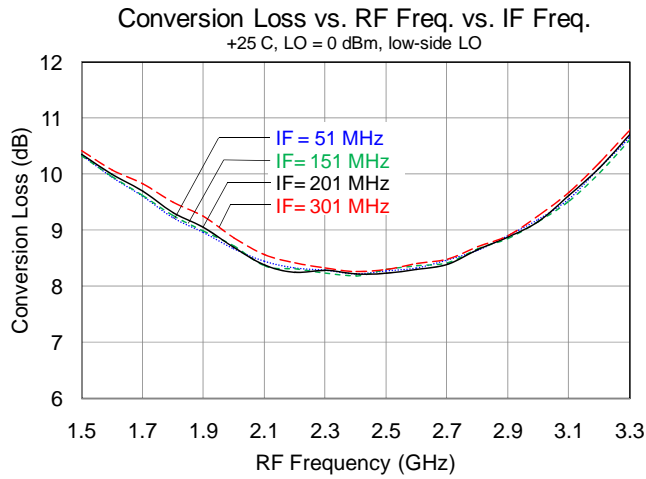
| Parameter              | Min       | Typ | Max | Min       | Typ | Max | Min       | Typ  | Max | Min       | Typ  | Max | Unit |
|------------------------|-----------|-----|-----|-----------|-----|-----|-----------|------|-----|-----------|------|-----|------|
| RF Freq Range          | 1700-1800 |     |     | 1800-2200 |     |     | 2300-2400 |      |     | 2500-2700 |      |     | MHz  |
| LO Freq Range          | 1400-1750 |     |     | 1500-2150 |     |     | 2000-2350 |      |     | 2200-2650 |      |     | MHz  |
| IF Freq Range          | 50-300    |     |     | 50-300    |     |     | 50-300    |      |     | 50-300    |      |     | MHz  |
| SSB Conversion Loss    |           | 9.4 |     |           | 8.7 | 10  |           | 8.5  |     |           | 9    |     | dB   |
| Input IP3 (see note 2) | +28       | +34 |     | +30       | +35 |     |           | +37  |     |           | +36  |     | dBm  |
| LO Leakage RF Port     |           | -5  |     |           | -2  |     |           | -1   |     |           | -1   |     | dBm  |
| LO Leakage IF Port     |           | -11 |     |           | -18 |     |           | -25  |     |           | -15  |     | dBm  |
| RF-IF Isolation        |           | 13  |     |           | 16  |     |           | 14   |     |           | 11   |     | dB   |
| RF Return Loss         |           | 13  |     |           | 13  |     |           | 15   |     |           | 16   |     | dB   |
| IF Return Loss         |           | 14  |     |           | 14  |     |           | 14   |     |           | 14   |     | dB   |
| LO Return Loss         |           | 10  |     |           | 10  |     |           | 12   |     |           | 13   |     | dB   |
| Input P1dB             |           | 20  |     |           | 20  |     |           | 19.5 |     |           | 19.5 |     | dBm  |
| LO Drive Level         | -2        | 0   | +4  | -2        | 0   | +4  | -2        | 0    | +4  | -2        | 0    | +4  | dBm  |

| Parameter                       | Min | Typ | Max | Unit |
|---------------------------------|-----|-----|-----|------|
| Supply Voltage                  |     | +5  |     | V    |
| Supply Current                  |     | 40  |     | mA   |
| Thermal Resistance (see note 3) |     |     | 84  | °C/W |

Notes:

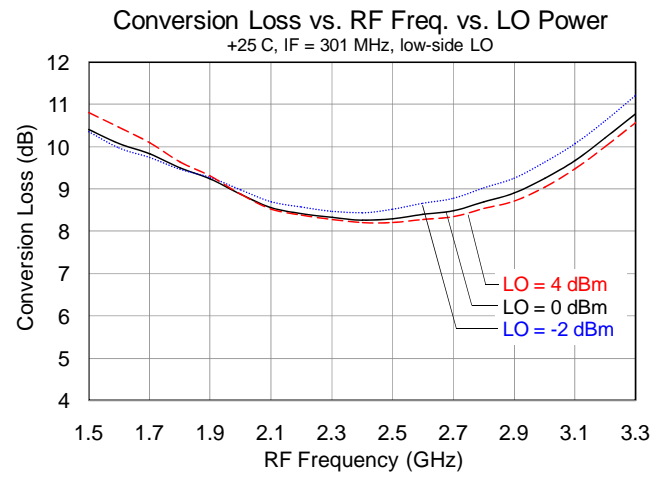
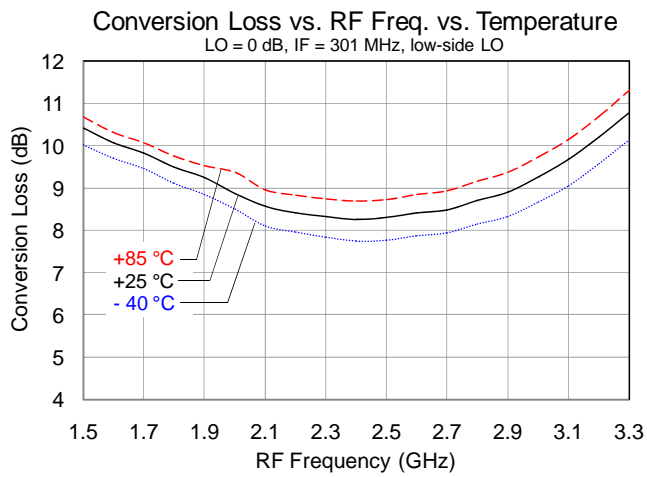
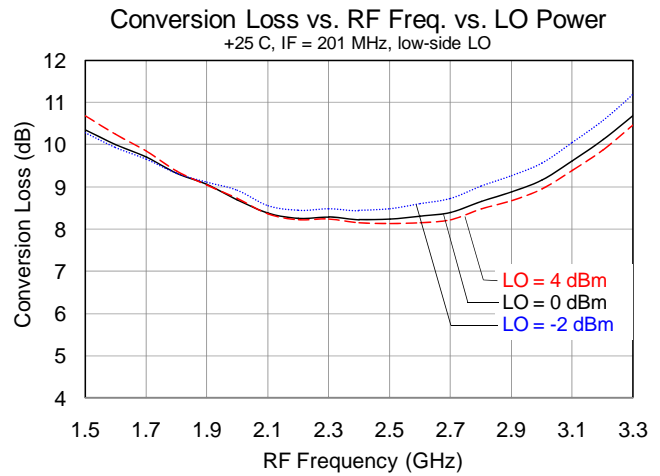
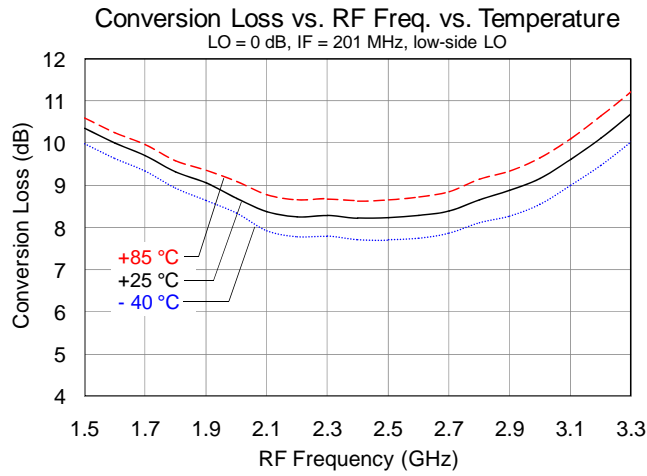
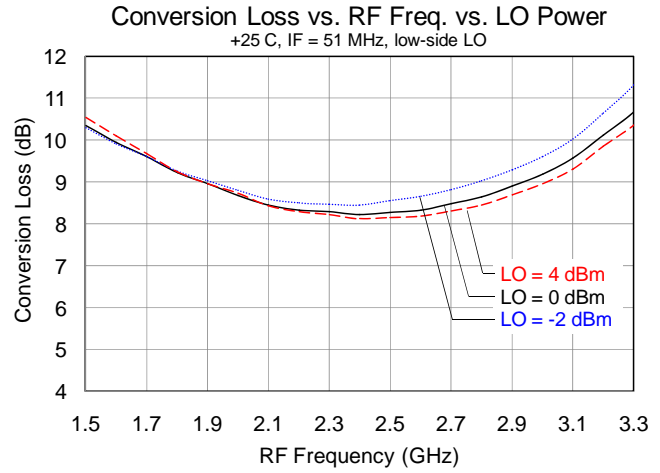
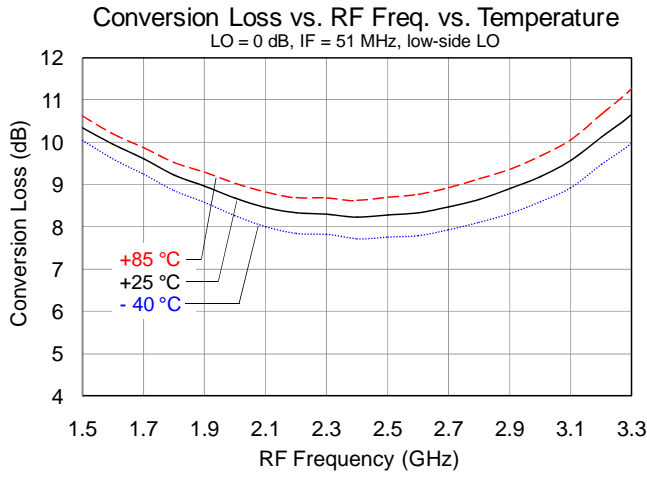
- Specifications are shown with 0dBm LO drive and IF = 200 MHz in a down converting configuration with a low-side LO.
- IIP3 is measured with Δf = 1 MHz with RFin = 0 dBm / tone.
- Thermal resistance is specified junction to case, θ<sub>jc</sub>

### Typical Performance Plots



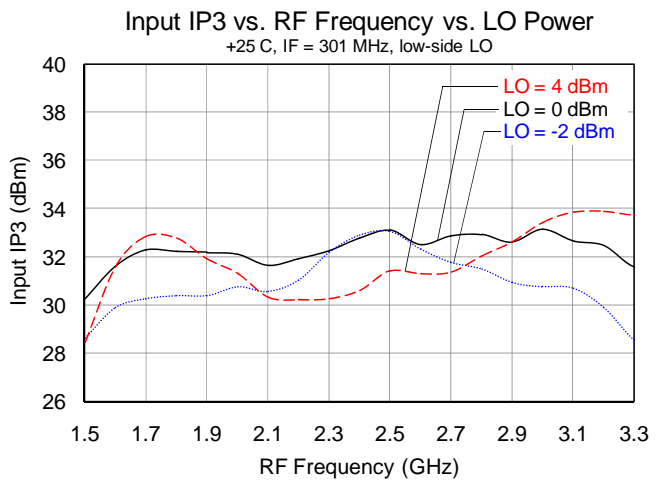
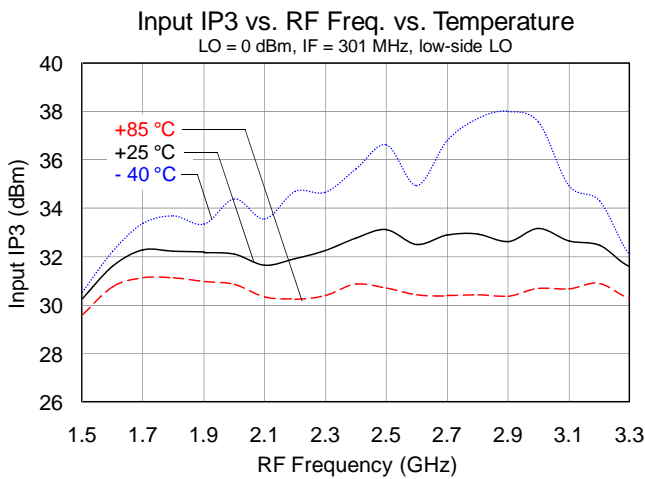
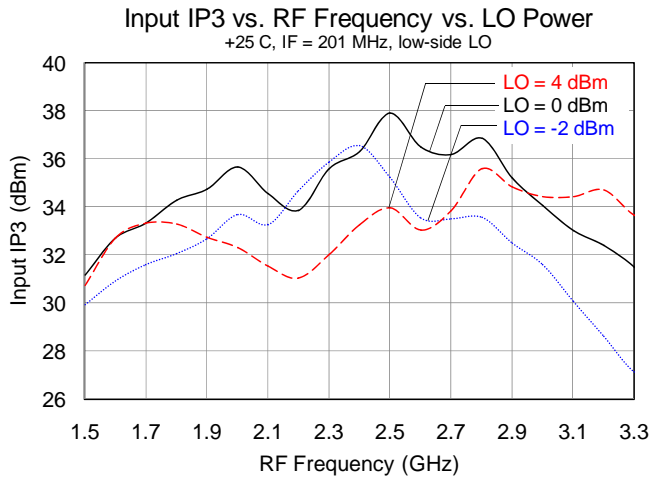
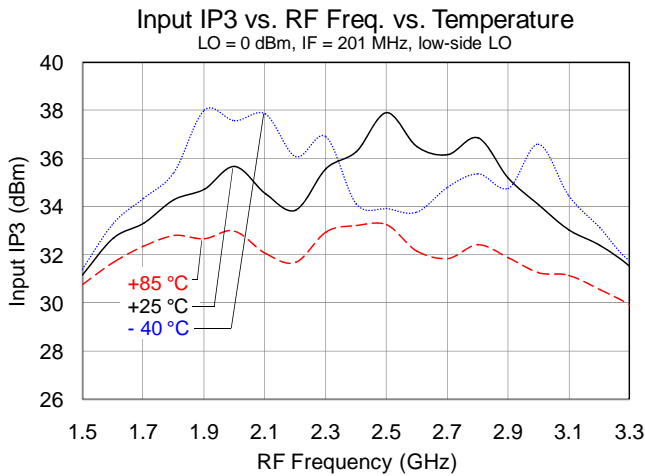
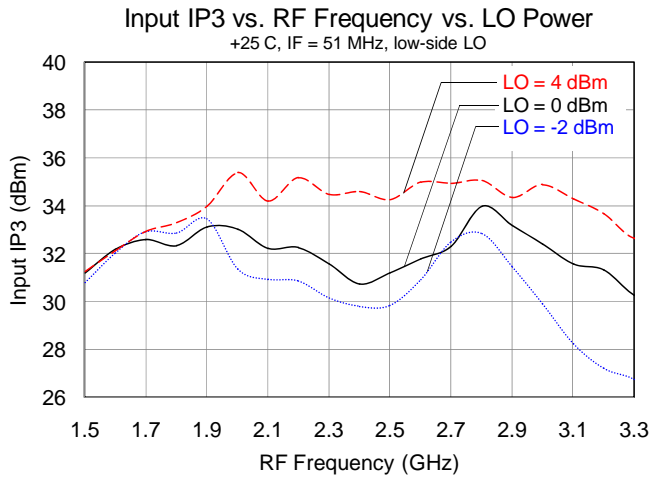
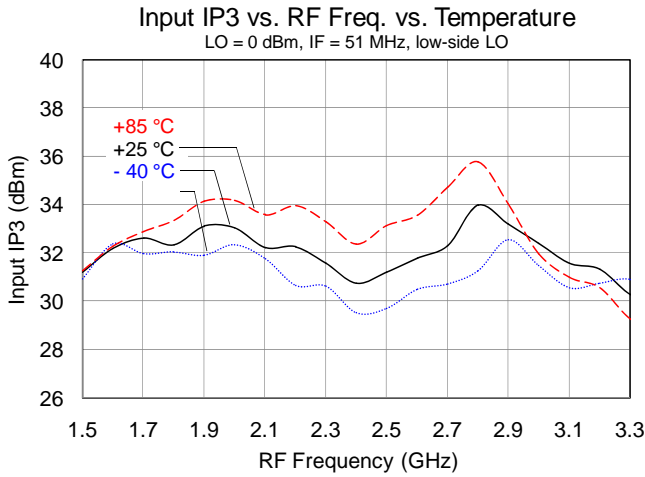
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## 1.5-3.2 GHz High IP3 Mixer with Integrated LO Amp



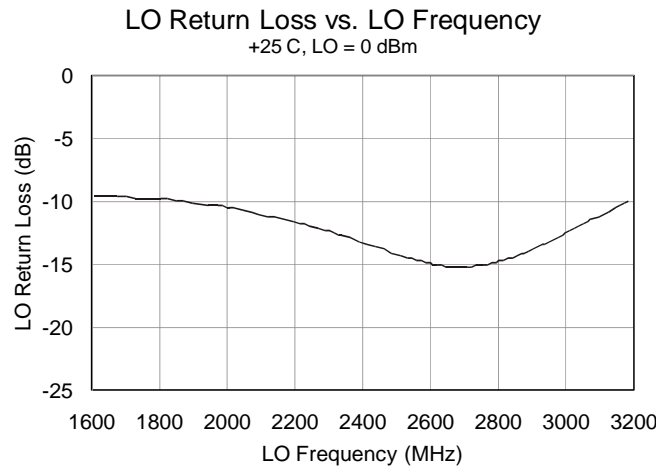
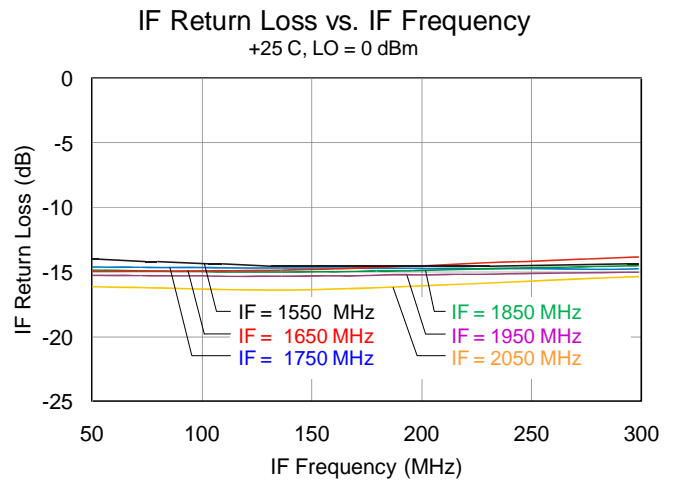
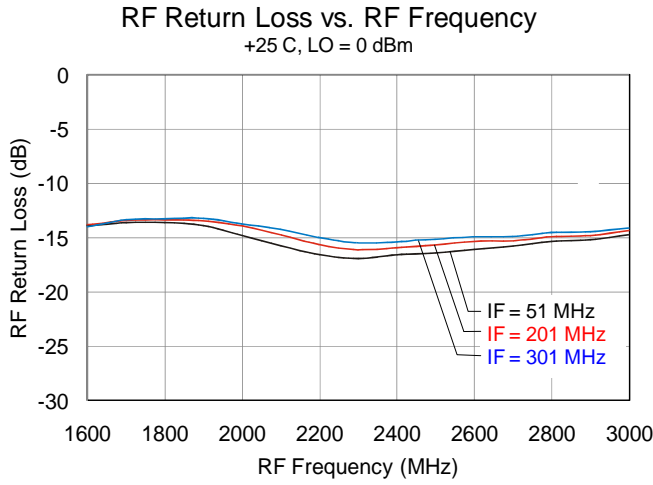
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### Spur Table

Spur tables is  $N \times f_{RF} - M \times f_{LO}$  mixer spurious products for 0 dBm input power, unless otherwise noted.  
RF Frequency = 1842 MHz, LO Frequency = 1642 MHz, All values in dBc relative to the IF Power Level.

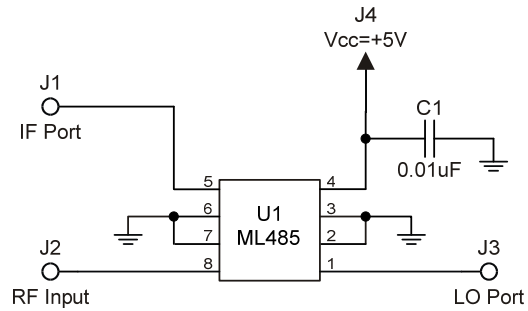
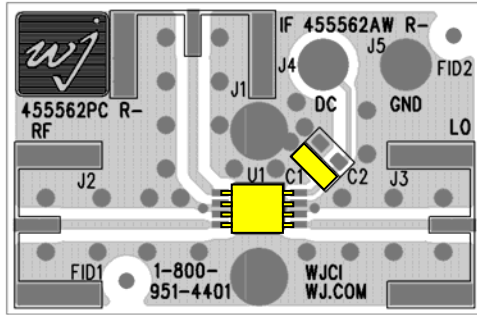
|   |   | M  |    |    |    |    |    |
|---|---|----|----|----|----|----|----|
|   |   | 0  | 1  | 2  | 3  | 4  | 5  |
| N | 0 |    | 2  | 22 | 35 | 18 | 85 |
|   | 1 | 3  | 0  | 30 | 23 | 47 | 35 |
|   | 2 | 47 | 81 | 39 | 51 | 57 | 70 |
|   | 3 | 87 | 80 | 94 | 72 | 78 | 81 |
|   | 4 | 95 | 93 | 91 | 93 | 88 | 88 |
|   | 5 | 95 | 95 | 95 | 92 | 95 | 95 |

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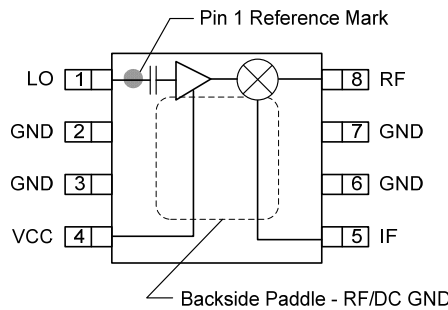
## 1.5-3.2 GHz High IP3 Mixer with Integrated LO Amp



### Down Conversion Applications Circuit: ML485-PCB



### Pin Description



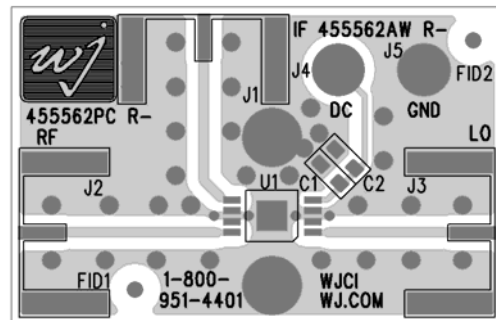
| Pin             | Symbol | Description   |
|-----------------|--------|---|
| 1               | LO     | Local Oscillator Injection. Internally DC Blocked   |
| 2, 3, 6, 7      | GND    | RF/DC Ground  |
| 4               | Vcc    | Supply voltage. An external bypass capacitor should be used near this pin.  |
| 5               | IF     | Intermediate Frequency  |
| 8               | RF     | Radio Frequency   |
| Backside Paddle | GND    | RF/DC Ground. Follow recommended via pattern and ensure good solder attach for best thermal and electrical performance. |

### Applications Information

#### PC Board Layout

Circuit Board Material: .014" FR-4, 4 layers (other layers added for rigidity), .062" total thickness, 1 oz copper  
 Microstrip line details: width = .026", spacing = .025"

The pad pattern shown has been developed and tested for optimized assembly at TriQuint Semiconductor. The PCB land pattern has been developed to accommodate lead and package tolerances. Since surface mount processes vary from company to company, careful process development is recommended.



For further technical information, Refer to [http://www.triquint.com/prodserv/more\\_info/default.aspx?prod\\_id=ML485](http://www.triquint.com/prodserv/more_info/default.aspx?prod_id=ML485)

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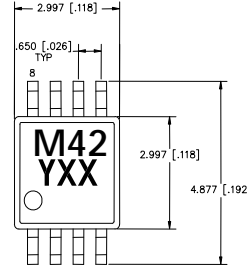
## 1.5-3.2 GHz High IP3 Mixer with Integrated LO Amp

### Mechanical Information

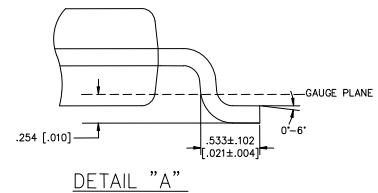
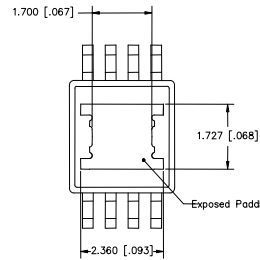
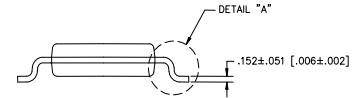
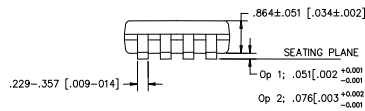
#### Package Information and Dimensions

This package is lead-free/green/RoHS-compliant. The plating material on the leads is 100 Percent Matte-Tin. It is compatible with both lead-free (maximum 260°C reflow temperature) and lead (maximum 245°C reflow temperature) soldering processes.

The ML485 will be marked with an “M42” designator with a lot code marked below the part designator. “Y” represents the last digit of the year the part was manufactured. “XX” is an auto-generated number.

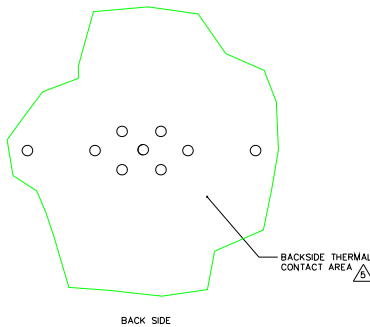
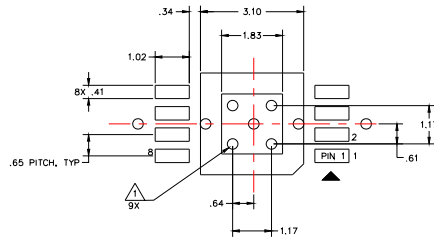
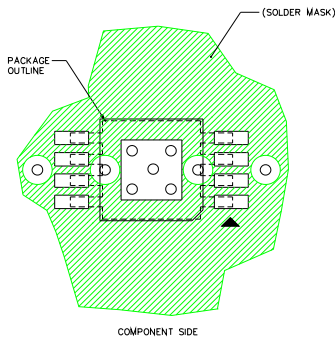


- NOTE:
- 1) ALL DIMENSIONS ARE IN MILLIMETERS [INCHES].
  - 2) PACKAGE LENGTH DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURR.
  - 3) PACKAGE WIDTH DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.



#### Mounting Configuration

All dimensions are in millimeters (inches). Angles are in degrees.



- NOTES:
1. GROUND/THERMAL VIAS ARE CRITICAL FOR THE PROPER PERFORMANCE OF THIS DEVICE. VIAS SHOULD USE A .35mm (#80/.0135") DIAMETER DRILL AND HAVE A FINAL, PLATED THRU DIAMETER OF .25mm (.010").
  2. ADD AS MUCH COPPER AS POSSIBLE TO INNER AND OUTER LAYERS NEAR THE PART TO ENSURE OPTIMAL THERMAL PERFORMANCE.
  3. TO ENSURE RELIABLE OPERATION, DEVICE GROUND PADDLE-TO-GROUND PAD SOLDER JOINT IS CRITICAL.
  4. ADD MOUNTING SCREWS NEAR THE PART TO FASTEN THE BOARD TO A HEATSINK. ENSURE THAT THE GROUND/THERMAL VIA REGION CONTACTS THE HEATSINK.
  5. FOR OPTIMAL THERMAL PERFORMANCE, EXPOSE SOLDERMASK ON BACKSIDE WHERE IT CONTACTS THE HEATSINK.
  6. RF TRACE WIDTH DEPENDS UPON THE PC BOARD MATERIAL AND CONSTRUCTION.
  7. USE 1 OZ. COPPER MINIMUM.
  8. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.



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## 1.5-3.2 GHz High IP3 Mixer with Integrated LO Amp

### Product Compliance Information

#### ESD Information



#### Caution! ESD-Sensitive Device

ESD Rating: Class 0  
Value: Passes/ 200 V to < 250 V  
Test: Human Body Model (HBM)  
Standard: JEDEC Standard JESD22-A114

ESD Rating: Class IV  
Value: Passes /500V  
Test: Charged Device Model (CDM)  
Standard: JEDEC Standard JESD22-C101

#### MSL Rating

Level 2 at +260 °C convection reflow  
JEDEC Standard J-STD-020

#### Solderability

Compatible with the latest version of J-STD-020, Lead free solder, 260°

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C<sub>15</sub>H<sub>12</sub>Br<sub>4</sub>O<sub>2</sub>) Free
- PFOS Free
- SVHC Free

### Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations, and information about TriQuint:

Web: [www.triquint.com](http://www.triquint.com)  
Email: [info-sales@tqs.com](mailto:info-sales@tqs.com)

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For technical questions and application information:

Email: [sjcapplications.engineering@tqs.com](mailto:sjcapplications.engineering@tqs.com)

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